

# **HAT2164H**

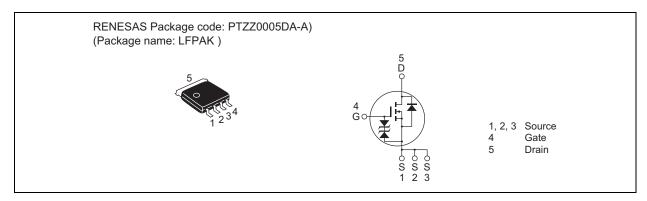
# Silicon N Channel Power MOS FET Power Switching

REJ03G0003-0500 Rev.5.00 Sep 26, 2005

### **Features**

- Capable of 4.5 V gate drive
- Low drive current
- High density mounting
- Low on-resistance  $R_{DS(on)}\!=\!2.5~m\Omega~typ.~(at~V_{GS}=10~V)$

### **Outline**



# **Absolute Maximum Ratings**

 $(Ta = 25^{\circ}C)$ 

Item	Symbol	Ratings	Unit
Drain to source voltage	$V_{DSS}$	30	V
Gate to source voltage	$V_{GSS}$	±20	V
Drain current	I <sub>D</sub>	60	А
Drain peak current	I <sub>D(pulse)</sub> Note1	240	А
Body-drain diode reverse drain current	I <sub>DR</sub>	60	Α
Avalanche current	I <sub>AP</sub> Note 2	30	Α
Avalanche energy	E <sub>AR</sub> Note 2	90	mJ
Channel dissipation	Pch Note3	30	W
Channel to Case Thermal Resistance	θch-C	4.17	°C/W
Channel temperature	Tch	150	°C
Storage temperature	Tstg	-55 to +150	°C

Notes: 1. PW ≤ 10 µs, duty cycle ≤ 1%

2. Value at Tch = 25°C, Rg  $\geq$  50  $\Omega$ 

3.  $Tc = 25^{\circ}C$ 

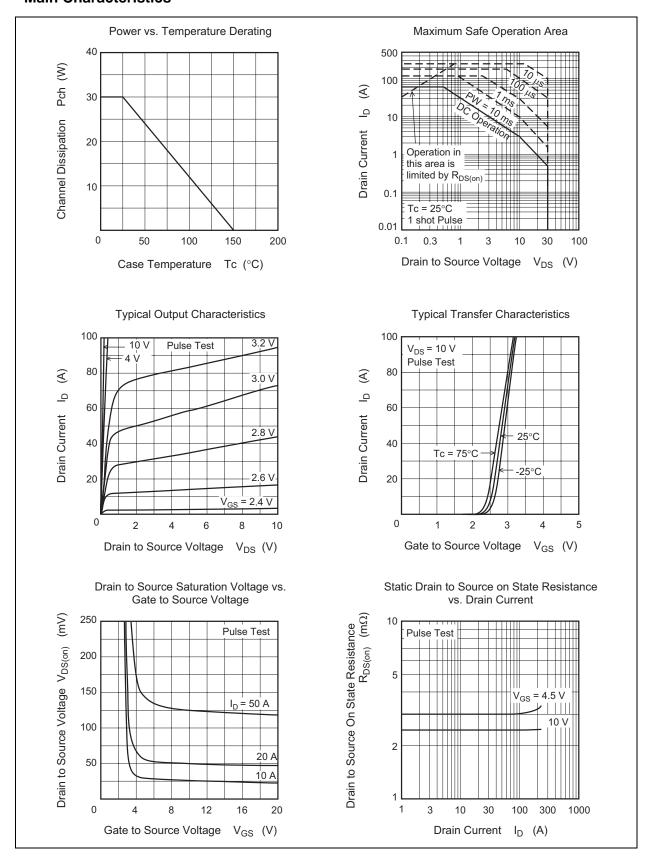
# **Electrical Characteristics**

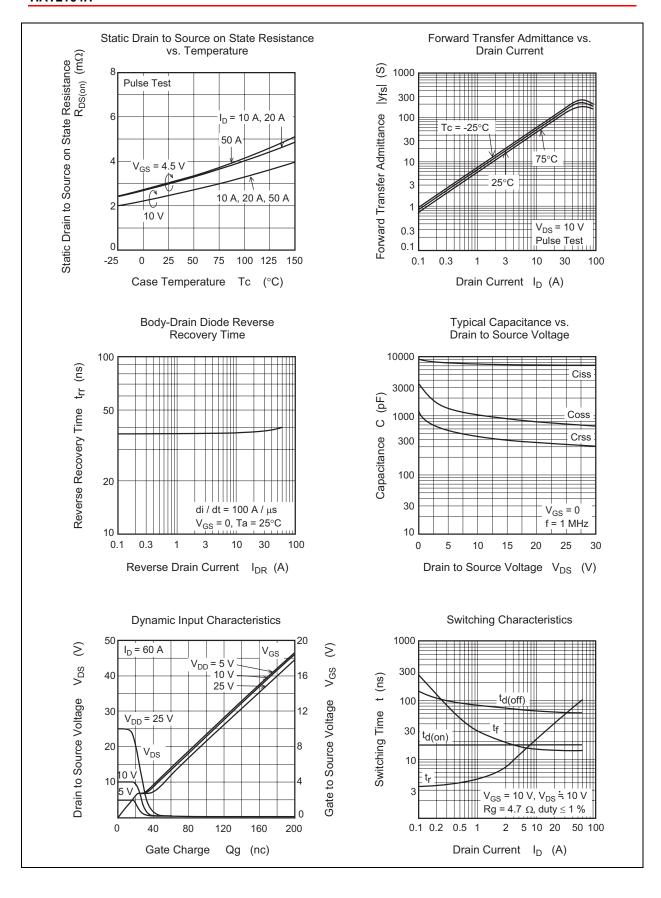
 $(Ta = 25^{\circ}C)$ 

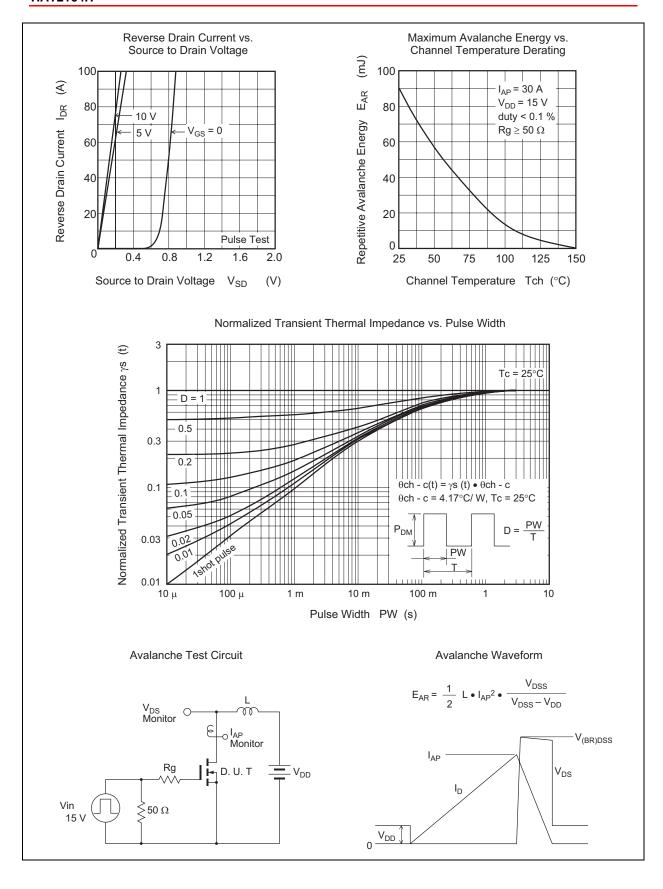
Item	Symbol	Min	Тур	Max	Unit	Test Conditions
Drain to source breakdown voltage	V <sub>(BR)DSS</sub>	30	_	_	V	$I_D = 10 \text{ mA}, V_{GS} = 0$
Gate to source breakdown voltage	V <sub>(BR)GSS</sub>	±20	_	_	V	$I_G = \pm 100 \ \mu A, \ V_{DS} = 0$
Gate to source leak current	I <sub>GSS</sub>	_	_	±10	μΑ	$V_{GS} = \pm 16 \text{ V}, V_{DS} = 0$
Zero gate voltage drain current	I <sub>DSS</sub>	_	_	1	μΑ	$V_{DS} = 30 \text{ V}, V_{GS} = 0$
Gate to source cutoff voltage	$V_{GS(off)}$	0.8	_	2.3	V	$V_{DS} = 10 \text{ V}, \text{ I }_{D} = 1 \text{ mA}$
Static drain to source on state	R <sub>DS(on)</sub>	_	2.5	3.1	mΩ	$I_D = 30 \text{ A}, V_{GS} = 10 \text{ V}^{\text{Note4}}$
resistance	R <sub>DS(on)</sub>	_	3.0	4.4	mΩ	$I_D = 30 \text{ A}, V_{GS} = 4.5 \text{ V}^{\text{Note4}}$
Forward transfer admittance	y <sub>fs</sub>	78	130	_	S	$I_D = 30 \text{ A}, V_{DS} = 10 \text{ V}^{\text{Note4}}$
Input capacitance	Ciss	_	7600	_	pF	$V_{DS} = 10 \text{ V}, V_{GS} = 0, f = 1 \text{ MHz}$
Output capacitance	Coss	_	1050	_	pF	
Reverse transfer capacitance	Crss	_	470	_	pF	
Gate Resistance	Rg	_	0.5	_	Ω	
Total gate charge	Qg	_	50	_	nC	$V_{DD} = 10 \text{ V}, V_{GS} = 4.5 \text{ V},$
Gate to source charge	Qgs	_	22	_	nC	I <sub>D</sub> = 60 A
Gate to drain charge	Qgd	_	10	_	nC	
Turn-on delay time	t <sub>d(on)</sub>	_	18	_	ns	$V_{GS} = 10 \text{ V}, I_D = 30 \text{ A},$
Rise time	t <sub>r</sub>	_	60	_	ns	$V_{DD}\cong 10~V,~R_L=0.33~\Omega,$
Turn-off delay time	t <sub>d(off)</sub>	_	65	_	ns	$Rg = 4.7 \Omega$
Fall time	t <sub>f</sub>	_	15	_	ns	
Body-drain diode forward voltage	$V_{DF}$	_	0.82	1.07	V	IF = 60 A, V <sub>GS</sub> = 0 Note4
Body-drain diode reverse recovery	t <sub>rr</sub>	_	40	_	ns	IF = 60 A, V <sub>GS</sub> = 0
time						$di_F/dt = 100 \text{ A}/\mu\text{s}$

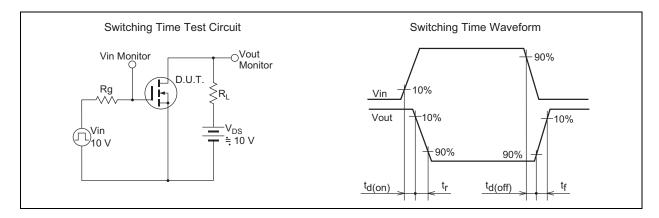
Notes: 4. Pulse test

# **Main Characteristics**

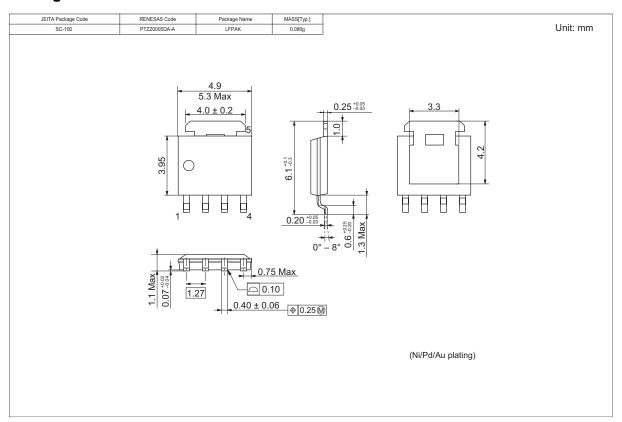








# **Package Dimensions**



# **Ordering Information**

Part Name	Quantity	Shipping Container
HAT2164H-EL-E	2500 pcs	Taping

Note: For some grades, production may be terminated. Please contact the Renesas sales office to check the state of production before ordering the product.

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